

TI's best practice recommendations												
System	Pin #	PIN Name	Component Name	Usage is?	Component Function	Typ. Value	Component Details	Layout Suggestions				
PRIMARY SIDE												
Analog-to- PWM	16	АРШМ	R _{ADC}	Optional	LPF converts PWM to analog signal	20kΩ	LPF is NOT used if the controller is taking the duty cycle and converting it to voltage in software X7R type	Place RC filter close to ADC/MCU input				
Channel			C _{ADC}	Optional		2200pF						
Bypass Caps	15	vcc	C _{BYP(VCC)1}	Required	High Value Decoupling Cap	100nF-1µF	X7R recommended	Place on same side ≤2mm away from the pin.				
			C _{BYP(VCC)2}	Required	Low value Decoupling Cap	1nF-100nF		Prioritize the placement of the smaller cap closer to the driver.				
	14		R _{RST}	Recommended	Input RC filter	100Ω						
Fault Reset		RST/EN		Recommended		100pF	X7R recommended	Place capacitor on the same side ≲2mm away from the pin				
Fault Signal	13	FLT	R _{FLT}	Required	Pullup Resistor	5.1k		Place capacitor on the same side ≤2mm away from the				
			C _{FLT}	Recommended	Filter cap	100pF	X7R recommended	pin				
Power-Good Signal	12	RDY	R _{RDY}	Required	Pullup Resistor	5.1k		Place capacitor on the same side ≤2mm away from the				
			C _{RDY}	Recommended	Filter cap	100pF	X7R recommended	pin				
PWM Input	11, 10	IN+, IN-	R _{IN+}	Recommended	Input RC Filter	100Ω	IN- is usually grounded unless differential signalling or interlock is used	Place capacitor on the same side ≤2mm away from the				
			CIN+	Recommended		100pF		pin				

		1		Optional				
	n/a		RL	Optional	Gate pull down resistor	10kΩ		
			CL	Optional	Capacitor to slow down gate dV/dt	1nF-100nF	50V rated, X7R recommended	Place as close to gate as possible. It's recommended to have placeholders for this component
IGBT/FET		Gate		Recommended		Low resistance		in a high power, fast switching application during a
			Ferrite Bead		Reduce gate ringing		Example Part number: MPZ1608S101A	prototype build to enable testing if necessary
						operation		
	8		C _{BYP(VDD)1}	Required	High Value VDD-COM Decoupling Cap	1µF-10µF		
		VDD	C _{BYP(VDD)2}	Required	Low Value VDD-COM Decoupling Cap	100nF-220nF	50V rated, X7R recommended	Place capacitor on the same side ≤2mm away from the
	5		C _{BYP(VEE)1}	Required	High Value VEE-COM Decoupling Cap	1µF-10µF		Prioritize the placement of the smaller value caps (2)
Bypass Caps		VEE	C _{BYP(VEE)2}	Required	Low Value VEE-COM Decoupling Cap	100nF-220nF	50V rated, X7R recommended	closest to the driver. It's recommended to have placeholders for these
			C _{BYP1}	Recommended	High Value VDD-VEE Decoupling Cap	1µF-10µF		components in a high power, fast switching application
			C _{BYP2}	Recommended	Low Value VDD-VEE Decoupling Cap	100nF-220nF	50V rated, X7R recommended	during a prototype build to enable testing if necessary.
				Required	Decoupling Cap			Keep the connection trace shorter between CLMPI pin to
Miller Clamp	7	CLMPI	NA					GATE
				Required				
	6	OUTL	R _{G(OFF)}		Gate pull-down resistance	2Ω-10Ω	Can be several parallel resistors	Highest priority layout (along with decoupling caps), Gate resistor should be placed close to gate as possible.
		-	D _{CLMPL}	Optional	Driver Output clamp	Schottky		Clamp diode close to driver pin.
	-		OLMIP E	Required		Schouky		clamp didde close to driver pin.
Gate Drive								It's recommended to have placeholders for these
	4		R _{G(ON)}		Gate pull-up resistance	2Ω-10Ω	Can be several parallel resistors	components in a high power, fast switching application
		OUTH						during a prototype build to enable testing if necessary.
			D _{CLMPH}	Optional	Driver Output clamp	Schottky		
			CAIN	Optional	Filtering Cap	100pF-10nF	X7R recommended	Place close to device pins
			R _{AIN}	Optional	I-V conversion	5kΩ		
APWM Input Conditioning	1	AIN	D _{AIN}	Optional	OV protection	5822	-5V Zener	1
Conditioning		0.0	R _{FII}	Recommended		100Ω-1kΩ		
			· · · · ·			10022-1822	X7R recommended	-
								1
			C	Recommended	RC Filter		The delay from the RC filter should be considered in the overall short-	
			C _{FIL} R _{SHUNT}	Required	Conversion	100pF-1nF	circuit/over-current detection time.	Place Close to Device
OC w/ Shunt	-		R _{FIL}	Recommended		Value selected base 100Ω-1kΩ	d on Peak collector current	Sensitive signal routing
			· · · · ·			10022-1822	X7R recommended	-
			C _{FIL}	Recommended	RC Filter	100pF-1nF	The delay from the RC filter should be considered in the overall short-	Place Close to Device
							· · · ·	
OC w/ SenseFET			R _{SNS}	Required	Sense Current I-V Conversion	Value selected hase	d on Peak collector current	Sensitive signal routing
	1	1						
			R _{1,2,3}	Required	Current source generation			Sensitive signal routing
		1	C _{BLK}	Required	Blanking capacitor			Place close to device
		1	D _{HV1,2}	Required	HV Block Diodes	1		Sensitive signal routing
OC as DESAT	2	00	D _{oc}	Recommended	OV Protection			Sensitive signal routing
	1-	100					1	

🜵 Texas Instruments

UCC217xx Calculator: OC (Over-Current)

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How to use this calculator: 1) Input system information in User Input (parameter descriptions are shown under Definitions). 2) Driver parameters from the datasheet are given in the Fixed Value section. 3) See Calculator Output for OC calculations based on the System and Driver Parameter values.

Note: OC configuration is only available with UCC21732 and UCC21710.

